

Electronic Acknowledgement Receipt

EFS ID:	1274694
Application Number:	10709428
International Application Number:	
Confirmation Number:	3427
Title of Invention:	CHIP-PACKAGING WITH BONDING OPTIONS CONNECTED TO A PACKAGE SUBSTRATE
First Named Inventor/Applicant Name:	Cheng-Yen Huang
Customer Number:	27765
Filer:	Winston Hsu
Filer Authorized By:	
Attorney Docket Number:	FTCP0035USA
Receipt Date:	27-OCT-2006
Filing Date:	05-MAY-2004
Time Stamp:	01:50:44
Application Type:	Utility

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part/.zip	Pages (if appl.)
1	Amendment - After Non-Final Rejection	FTCP0035USA0_A2_6_Amd.pdf	620538	no	1

Warnings:

Information:					
2	Claims	FTCP0035USA0_A2_6_Cla.pdf	620480	no	4
Warnings:					
Information:					
3	Applicant Arguments/Remarks Made in an Amendment	FTCP0035USA0_A2_6_Re.m.pdf	620475	no	4
Warnings:					
Information:					
Total Files Size (in bytes):			1861493		
<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p>New Applications Under 35 U.S.C. 111 If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p>National Stage of an International Application under 35 U.S.C. 371 If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>					